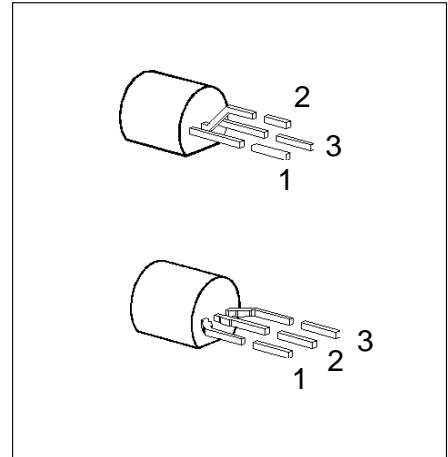


- $V_{DS}$  60 V
- $I_D$  0.3 A
- $R_{DS(on)}$  5.0  $\Omega$
- $V_{GS(th)}$  0.8 ... 2.0 V
- N channel
- Enhancement mode
- Logic level



Type	Ordering Code	Tape and Reel Information	Pin Configuration			Marking	Package
			1	2	3		
BS 170	Q67000-S061	bulk	S	G	D	BS 170	TO-92
BS 170	Q67000-S076	E6288: 1500 pcs/reel; 2 reels/carton; gate first					

### Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{DS}$	60	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	$V_{DGR}$	60	
Gate-source voltage	$V_{GS}$	$\pm 14$	
Gate-source peak voltage, aperiodic	$V_{gs}$	$\pm 20$	
Continuous drain current, $T_A = 25 \text{ }^\circ\text{C}$	$I_D$	0.3	A
Pulsed drain current, $T_A = 25 \text{ }^\circ\text{C}$	$I_{D \text{ puls}}$	1.2	
Max. power dissipation, $T_A = 25 \text{ }^\circ\text{C}$	$P_{tot}$	0.63	W
Operating and storage temperature range	$T_j, T_{stg}$	$-55 \dots +150$	$^\circ\text{C}$
Thermal resistance, chip-ambient (without heat sink)	$R_{thJA}$	$\leq 200$	K/W
DIN humidity category, DIN 40 040	–	E	–
IEC climatic category, DIN IEC 68-1	–	55/150/56	–

## Electrical Characteristics

at  $T_j = 25\text{ °C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

## Static Characteristics

Drain-source breakdown voltage $V_{GS} = 0, I_D = 0.25\text{ mA}$	$V_{(BR)DSS}$	60	–	–	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1\text{ mA}$	$V_{GS(th)}$	0.8	1.4	2.0	
Zero gate voltage drain current $V_{DS} = 60\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$ $V_{DS} = 50\text{ V}, V_{GS} = 0$ $T_j = 125\text{ °C}$	$I_{DSS}$	–	0.05	0.5	$\mu\text{A}$
Gate-source leakage current $V_{GS} = 20\text{ V}, V_{DS} = 0$	$I_{GSS}$	–	1	10	nA
Drain-source on-resistance $V_{GS} = 10\text{ V}, I_D = 0.2\text{ A}$	$R_{DS(on)}$	–	2.5	5.0	$\Omega$

## Dynamic Characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = 0.2\text{ A}$	$g_{fs}$	0.12	0.18	–	S
Input capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{iss}$	–	40	60	$\text{pF}$
Output capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{oss}$	–	15	25	
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{rss}$	–	5	10	
Turn-on time $t_{on}, (t_{on} = t_{d(on)} + t_r)$ $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.29\text{ A}$	$t_{d(on)}$	–	5	8	ns
	$t_r$	–	8	12	
Turn-off time $t_{off}, (t_{off} = t_{d(off)} + t_f)$ $V_{DD} = 30\text{ V}, V_{GS} = 10\text{ V}, R_{GS} = 50\text{ }\Omega, I_D = 0.29\text{ A}$	$t_{d(off)}$	–	12	16	
	$t_f$	–	17	22	

## Electrical Characteristics (cont'd)

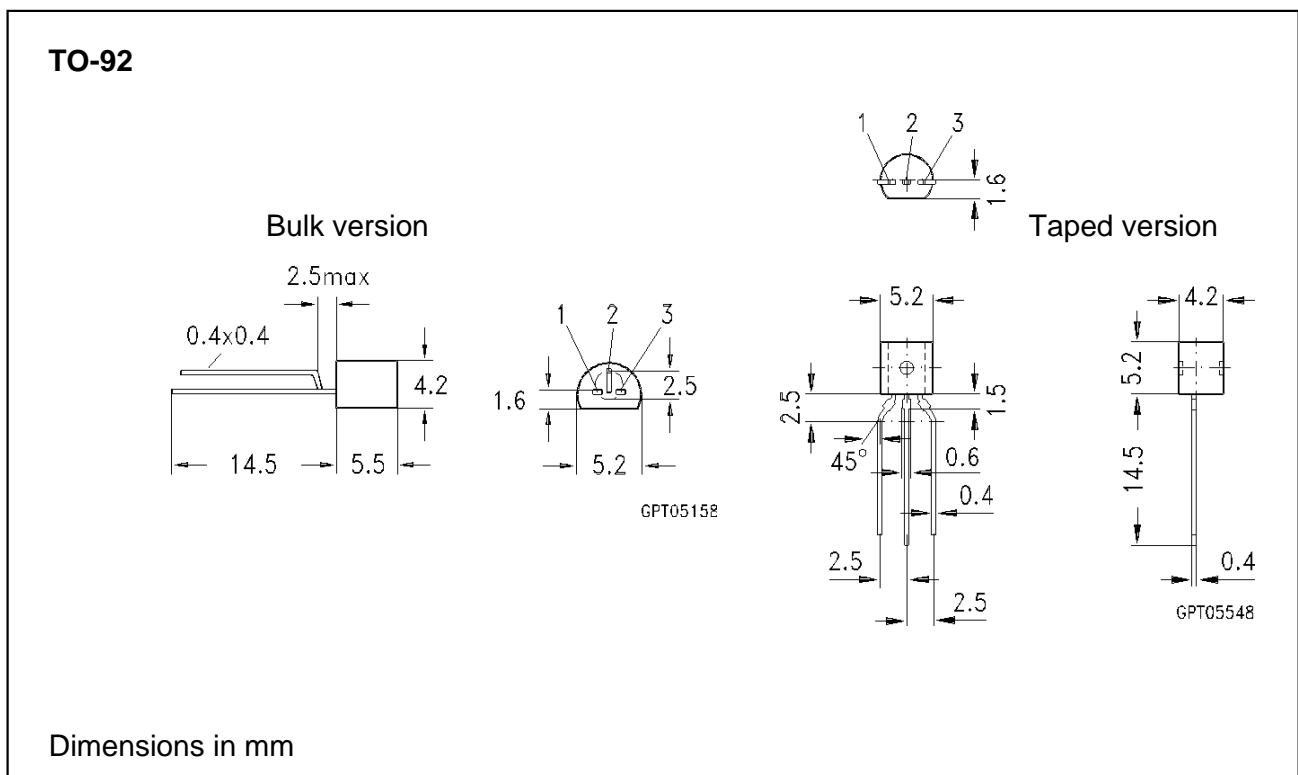
at  $T_j = 25\text{ °C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

### Reverse Diode

Continuous reverse drain current $T_A = 25\text{ °C}$	$I_S$	—	—	0.3	A
Pulsed reverse drain current $T_A = 25\text{ °C}$	$I_{SM}$	—	—	1.2	
Diode forward on-voltage $I_F = 0.5\text{ A}$ , $V_{GS} = 0$	$V_{SD}$	—	0.9	1.2	V

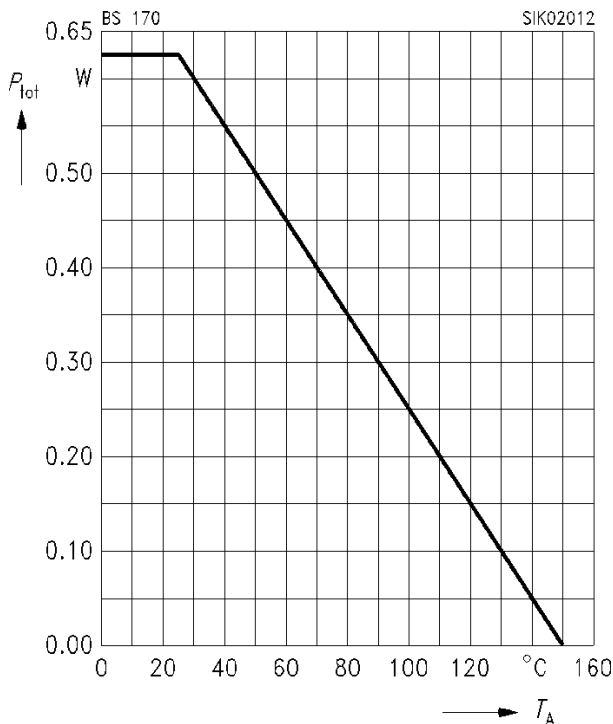
## Package Outline



### Characteristics

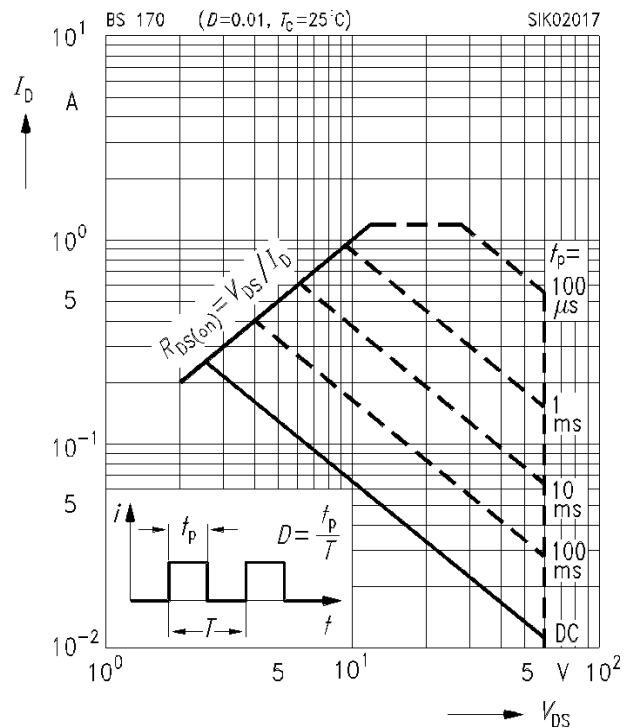
at  $T_j = 25\text{ }^\circ\text{C}$ , unless otherwise specified.

Total power dissipation  $P_{\text{tot}} = f(T_A)$



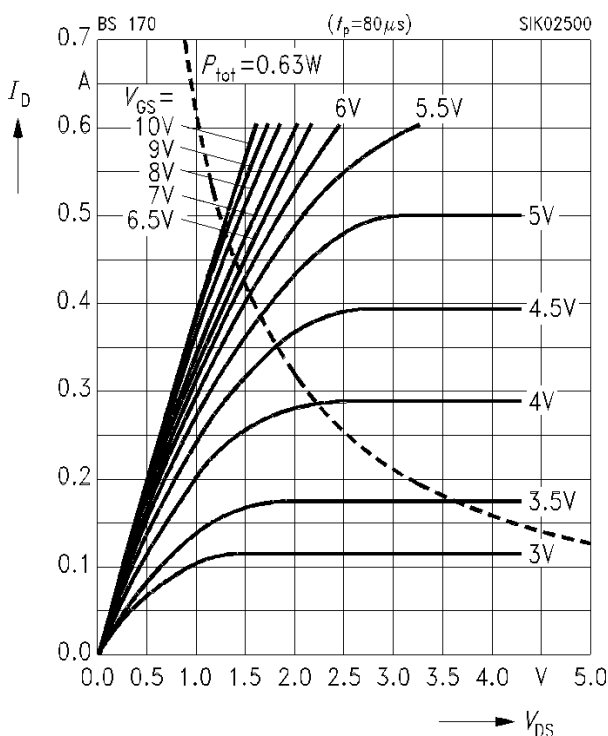
Safe operating area  $I_D = f(V_{\text{DS}})$

parameter:  $D = 0.01$ ,  $T_C = 25\text{ }^\circ\text{C}$



Typ. output characteristics  $I_D = f(V_{\text{DS}})$

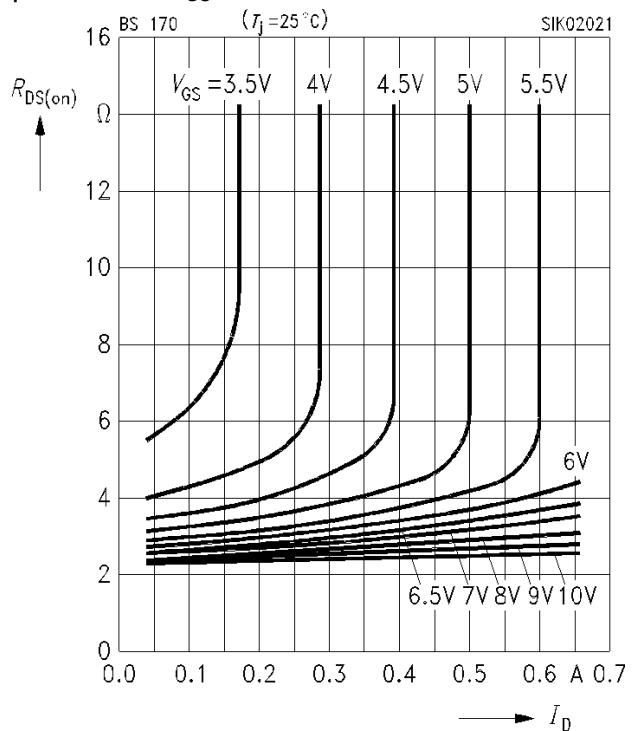
parameter:  $t_p = 80\text{ } \mu\text{s}$



Typ. drain-source on-resistance

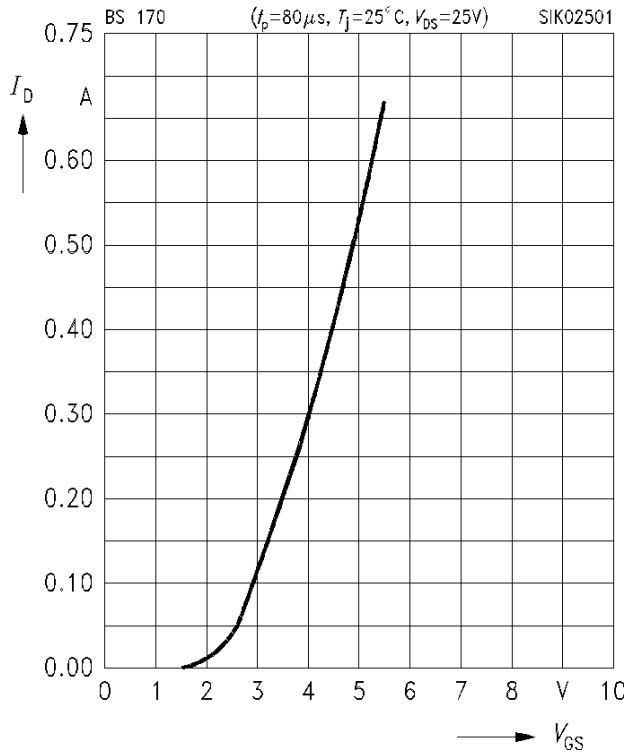
$R_{\text{DS(on)}} = f(I_D)$

parameter:  $V_{\text{GS}}$



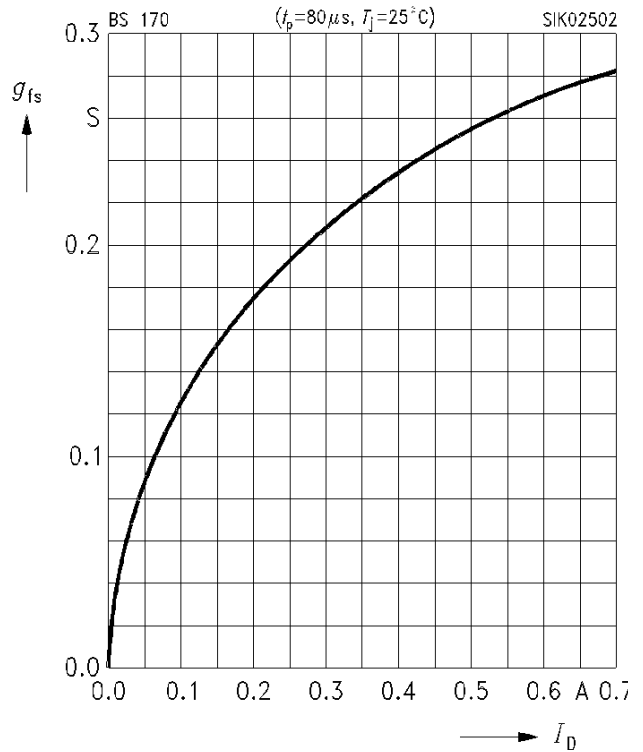
### Typ. transfer characteristics $I_D = f(V_{GS})$

parameter:  $t_p = 80 \mu s$ ,  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$



### Typ. forward transconductance $g_{fs} = f(I_D)$

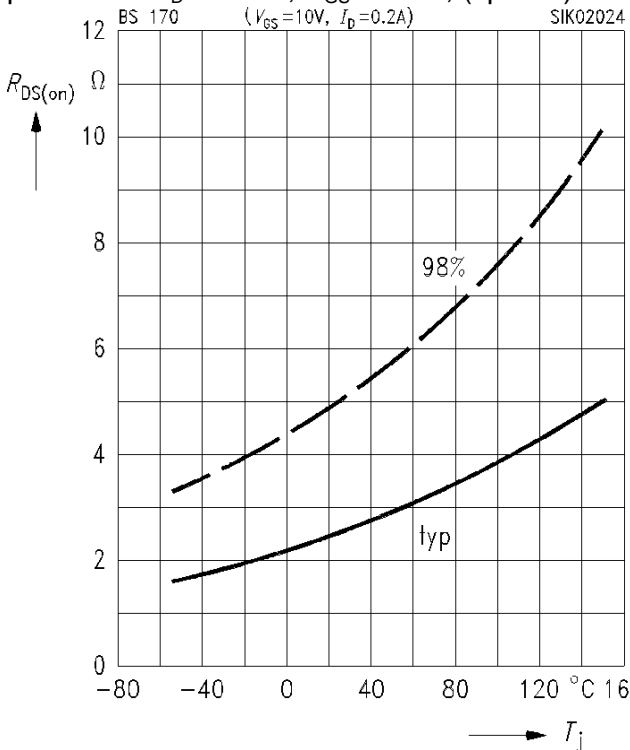
parameter:  $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$ ,  $t_p = 80 \mu s$



### Drain-source on-resistance

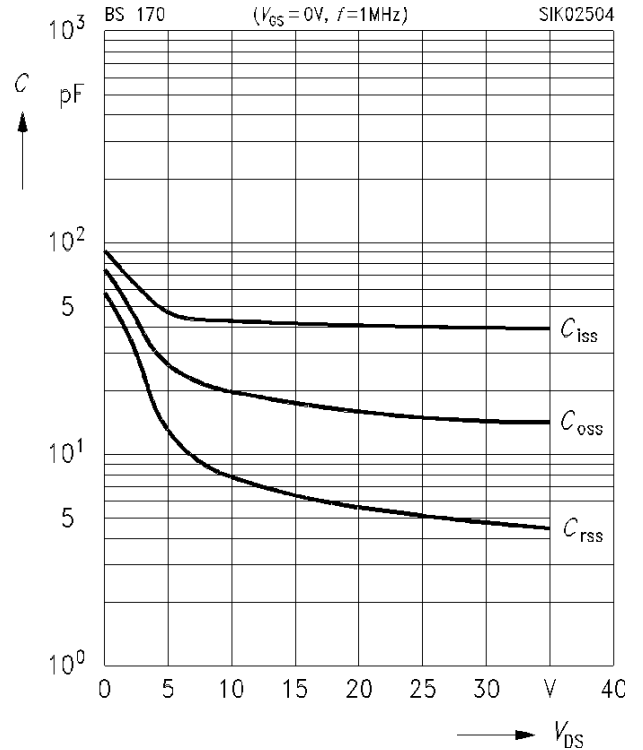
$$R_{DS(on)} = f(T_j)$$

parameter:  $I_D = 0.2 A$ ,  $V_{GS} = 10 V$ , (spread)

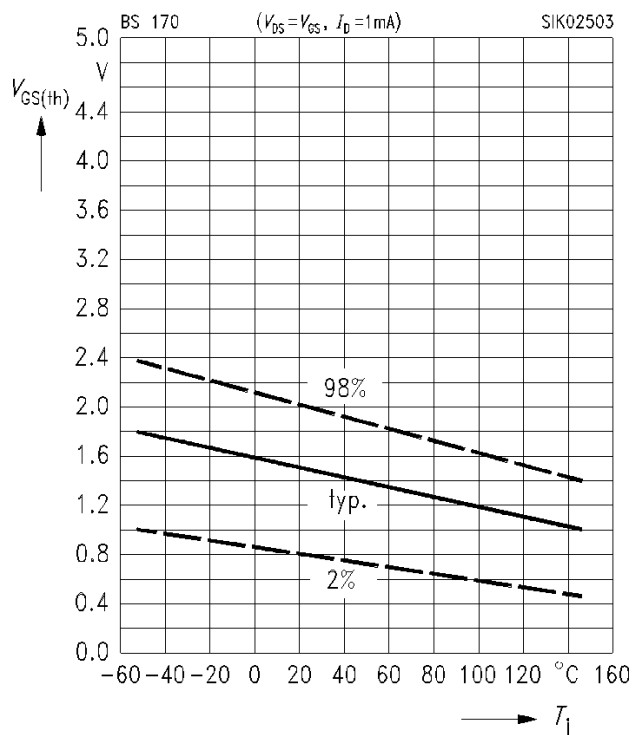


### Typ. capacitances $C = f(V_{DS})$

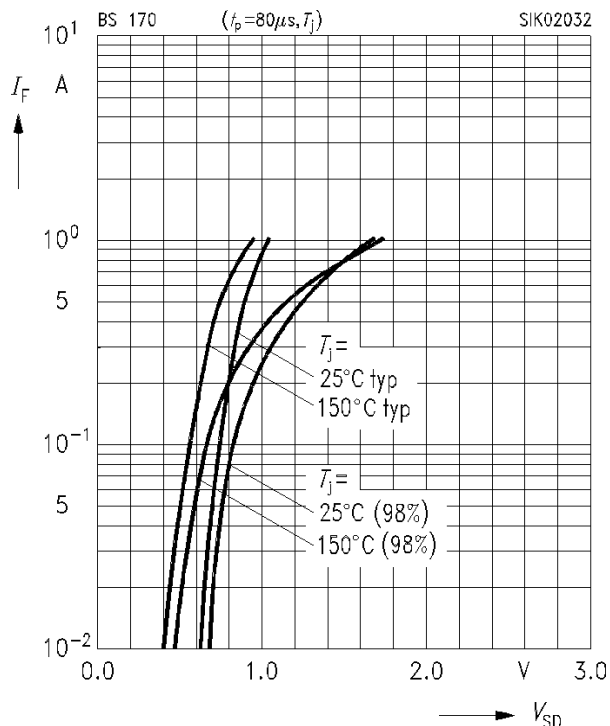
parameter:  $V_{GS} = 0V$ ,  $f = 1 MHz$



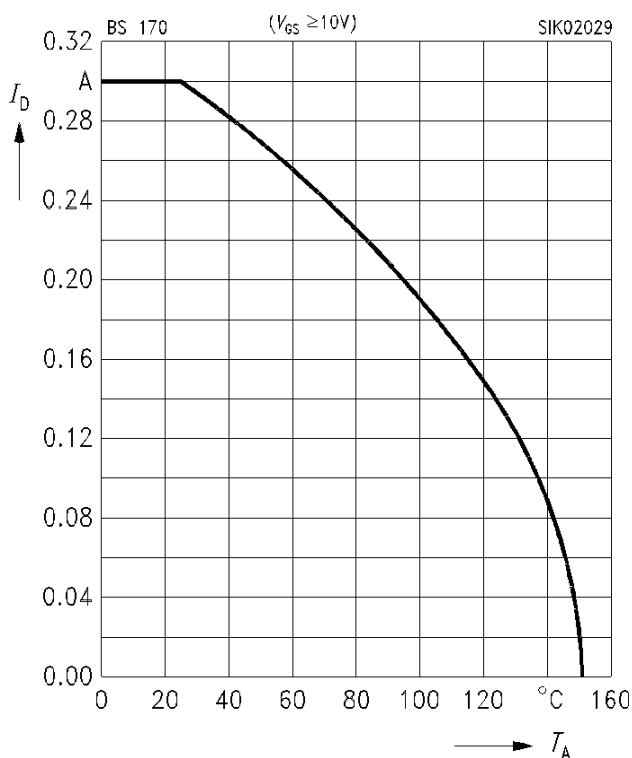
**Gate threshold voltage**  $V_{GS(th)} = f(T_j)$   
 parameter:  $V_{DS} = V_{GS}$ ,  $I_D = 1 \text{ mA}$ , (spread)



**Forward characteristics of reverse diode**  
 $I_F = f(V_{SD})$   
 parameter:  $t_p = 80 \mu\text{s}$ ,  $T_j$  (spread)



**Drain current**  $I_D = f(T_A)$   
 parameter:  $V_{GS} \geq 5 \text{ V}$



**Drain-source on breakdown voltage**  
 $V_{(BR)DSS} = b \times V_{(BR)DSS} (25 \text{ °C})$

